Technical Data Sheet

Reverse Package Chip LED with inner Lens

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.

Descriptions

- The 25-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

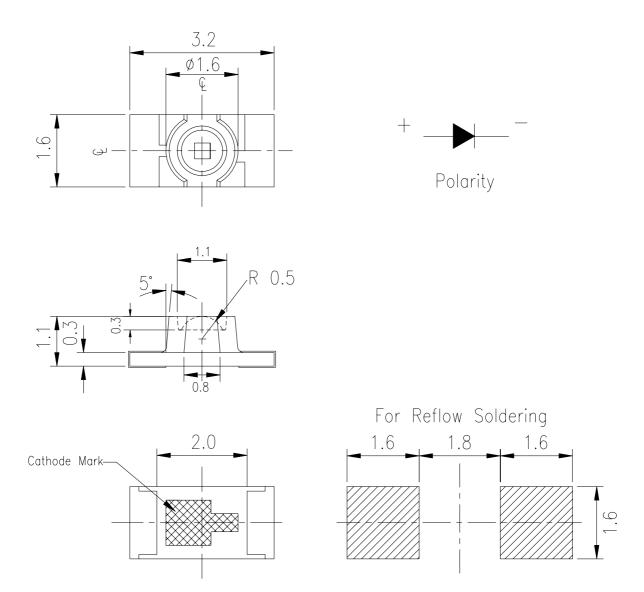
Part No.	Chip		Long Color	
	Material	Emitted Color	Lens Color	
25-21UY/S530-A2/TR8	AlGalnP	Super Yellow	Water Clear	



25-21UYC/S530-A2/TR8



Package Outline Dimensions



Note: The tolerance unless mentioned is ± 0.1 mm , unit is mm.

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25-21UYC/S530-A2/TR8

Absolute Maximum Ratings (Ta=25°C)

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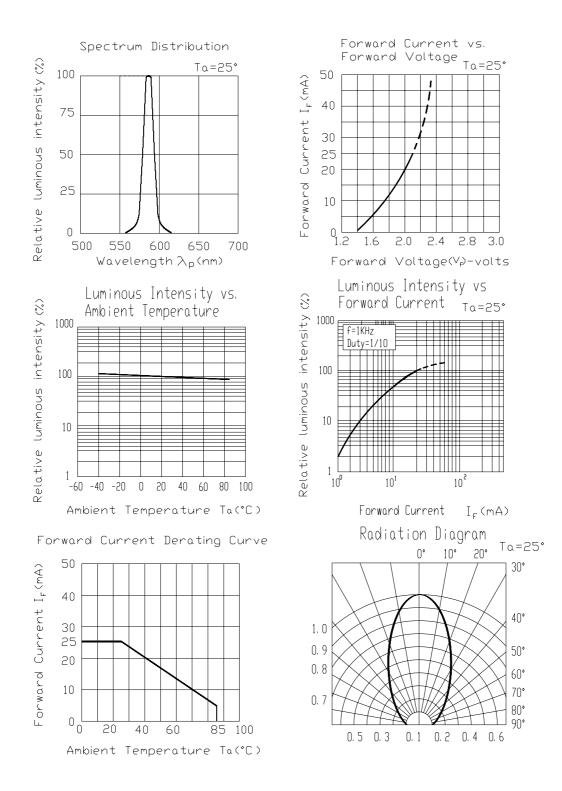
Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40~ +90	°C	
	T 1	260	°C	
Soldering Temperature	Tsol	(for 5 second)		
Electrostatic Discharge	ESD	2000	V	
Power Dissipation	Pd	60	mW	
Peak Forward Current	T	(0)		
(Duty 1/10 @1KHz)	Ifp	60	mA	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	18	45		mcd	
Viewing Angle	$2 \theta 1/2$		60		deg	
Peak Wavelength	λp		591		nm	
Dominant Wavelength	λd		589		nm	IF=20mA
Spectrum Radiation Bandwidth	$ riangle \lambda$		15		nm	
Forward Voltage	VF		2.0	2.4	V	
Reverse Current	Ir			10	μA	V _R =5V

25-21UYC/S530-A2/TR8

Typical Electro-Optical Characteristics Curves



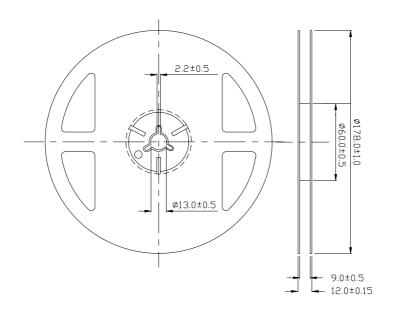
25-21UYC/S530-A2/TR8

Label explanation

- **CAT: Luminous Intensity Rank**
- HUE: Dom. Wavelength Rank
- **REF: Forward Voltage Rank**



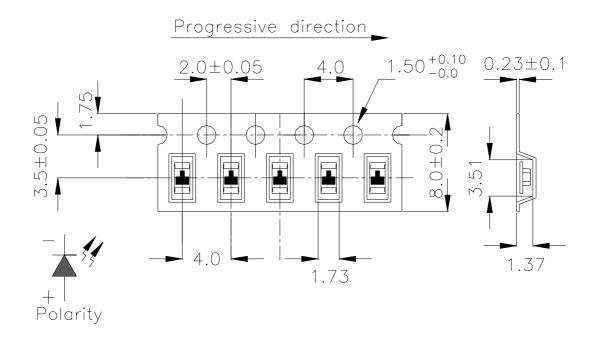
Reel Dimensions



Note: The tolerance unless mentioned is ± 0.1 mm, unit is mm.

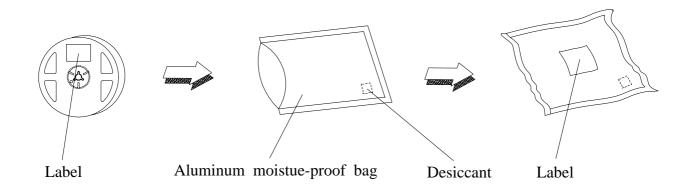
25-21UYC/S530-A2/TR8

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerance unless mentioned is ± 0.1 mm, unit is mm.

Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

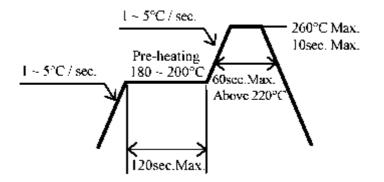
No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H: +100°C 15min $\int 5 \text{ min}$ L: -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
б	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90% RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30° C or less and 70% RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
 Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

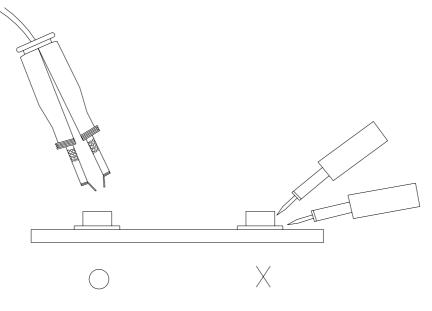
4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.



5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Everlight Electronics Co., Ltd. Device No. : DSE-251-005 http://www.everlight.com Prepared date: 08-03-2004 Rev.1.1Page: 9 of 9Prepared by: Malone Yu